

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	1383127
<b>Application Number:</b>	10810634
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	9586
<b>Title of Invention:</b>	METHOD FOR SEPARATING SAPPHIRE WAFER INTO CHIPS USING DRY-ETCHING
<b>First Named Inventor/Applicant Name:</b>	Ju Hyun Kim
<b>Customer Number:</b>	22429
<b>Filer:</b>	Benjamin J. Hauptman/Ayesha Wilson
<b>Filer Authorized By:</b>	Benjamin J. Hauptman
<b>Attorney Docket Number:</b>	2336-256
<b>Receipt Date:</b>	18-DEC-2006
<b>Filing Date:</b>	29-MAR-2004
<b>Time Stamp:</b>	19:15:21
<b>Application Type:</b>	Utility

### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed	2006-12-18-IDS.pdf	102102	no	2

### Warnings:

**Information:**

This is not an USPTO supplied IDS fillable form

2	Foreign Reference	JP10-27769.pdf	652023	no	8
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**Warnings:****Information:**

3	Foreign Reference	JP2000-68556andEngAbstract.pdf	485575	no	8
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**Warnings:****Information:**

4	Foreign Reference	JP2003-179023andEngAbstract.pdf	1136500	no	12
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**Warnings:****Information:**

5	Foreign Reference	JP2001257186andEngAbstract.pdf	1155099	no	13
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**Warnings:****Information:**

6	NPL Documents	2006-12-18-JPOOA.pdf	87957	no	2
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**Warnings:****Information:**

Total Files Size (in bytes):	3619256
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**New Applications Under 35 U.S.C. 111**

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

**National Stage of an International Application under 35 U.S.C. 371**

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.